

TOSHIBA Photointerrupter Infrared LED + Photo IC

TLP1004A(F), TLP1005A(F)

Lead Free Product

Home Electric Equipment Such As VCR,
CD Player

OA Equipment Such As Copying
Machine, Printer, Facsimile, Etc.

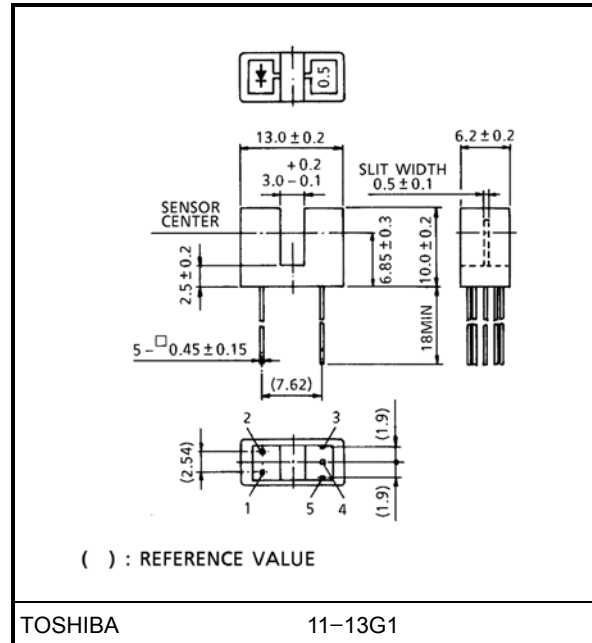
Automatic service Equipment Such As
Vending Machine,

Various Position Detection

TLP1004A(F) and TLP1005A(F) are digital output photo-interrupters combining GaAs infrared LED with high sensitive and high gain Si photo IC. Directly connectable to TTL, LSTTL and CMOS.

- Printed wiring board direct mounting type
- Gap: 3mm
- Resolution: Slit width 0.5mm
- Digital output (with a pull-up resistor)
 - TLP1004A(F): Low level output at shielding
 - TLP1005A(F): High level output at shielding
- Built-in schmitt circuit
- Threshold input current: 4mA (max.) at Ta = 25°C
- Operating supply voltage: VCC = 4.5V~17V
- High speed response
- Detector side is of visible light cut type

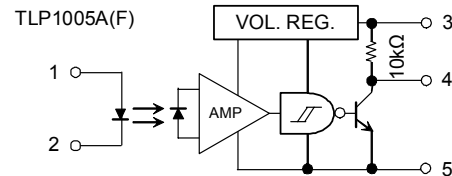
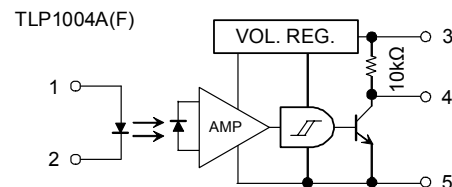
Unit in mm



TOSHIBA 11-13G1

Weight: 0.8g (typ.)

Pin Connection



- 1. Anode
- 2. Cathode
- 3. VCC
- 4. OUT
- 5. GND

Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I_F	50	mA
	Forward current derating (Ta > 25°C)	$\Delta I_F / ^\circ\text{C}$	-0.33	mA / °C
	Reverse voltage	V_R	5	V
Detector	Supply voltage	V_{CC}	17	V
	Output current	I_O	50	mA
	Power dissipation	P_O	250	mW
	Power dissipation derating (Ta > 25°C)	$\Delta P_O / ^\circ\text{C}$	-3.33	mW / °C
Operating temperature range		T_{opr}	-25~85	°C
Storage temperature range		T_{stg}	-40~100	°C
Soldering temperature (5 s)		T_{sol}	260	°C

Recommended Operating Condition

Characteristic	Symbol	Min.	Typ.	Max.	Unit
LED forward current	I_F	14*	—	20	mA
Supply voltage	V_{CC}	4.5	5.0	17	V
Low level output current	I_{OL}	—	—	16	mA
Operating temperature	T_{opr}	-25	—	85	°C

* 14mA is a value considering 50% LED deterioration.
Initial value of the threshold input current is 7mA.

Opto-Electrical Characteristics

(unless otherwise specified, Ta = -25~85°C, VCC = 5V ±10%)

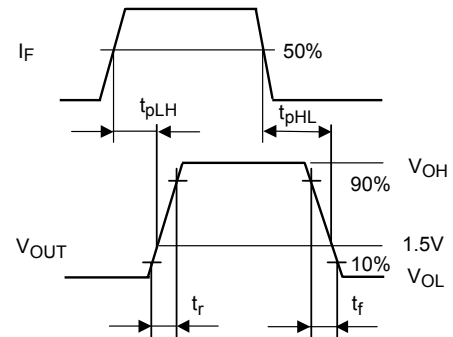
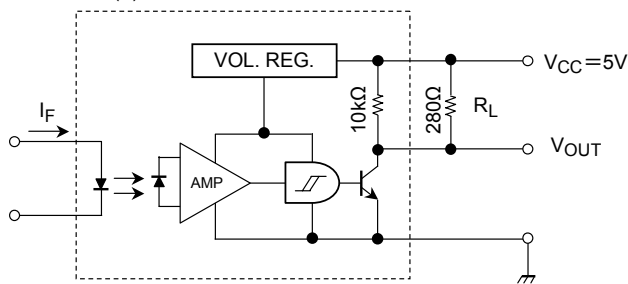
Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit	
LED	Forward voltage	V_F	$I_F = 10\text{mA}$, $T_a = 25^\circ\text{C}$	1.00	1.15	1.30	V	
	Reverse current	I_R	$V_R = 5\text{V}$, $T_a = 25^\circ\text{C}$	—	—	10	μA	
	Peak emission wavelength	λ_P	$I_F = 15\text{mA}$, $T_a = 25^\circ\text{C}$	—	940	—	nm	
Detector	Operating supply voltage	V_{CC}	—	4.5	—	17	V	
	Low level supply current	I_{CCL}	$I_F = *1$	—	—	6.0	mA	
			$I_F = *1$, $V_{CC} = 17\text{V}$	—	—	7.5		
	High level supply current	I_{CCH}	$I_F = *2$	—	—	3.0	mA	
			$I_F = *2$, $V_{CC} = 17\text{V}$	—	—	3.2		
	Low level output voltage	V_{OL}	$I_{OL} = 16\text{mA}$, $I_F = *1$ $T_a = 25^\circ\text{C}$	—	0.07	0.3	V	
			$I_{OL} = 16\text{mA}$, $I_F = *1$ $V_{CC} = 17\text{V}$	—	—	0.4		
High level output voltage	V_{OH}	$I_F = *2$	$0.9V_{CC}$	—	—			
Peak sensitivity wavelength	λ_P	$T_a = 25^\circ\text{C}$	—	900	—	nm		
Coupled	L → H threshold input current	I_{FLH}	$T_a = 25^\circ\text{C}$	TLP1004A(F)	—	—	4	mA
			$V_{CC} = 17\text{V}$		—	—	7	
	H → L threshold input current	I_{FHL}	$T_a = 25^\circ\text{C}$	TLP1005A(F)	—	—	4	mA
			$V_{CC} = 17\text{V}$		—	—	7	
	Hysteresis ratio	I_{FHL} / I_{FLH}	—	TLP1004A(F)	—	0.67	—	—
				TLP1005A(F)	—	1.5	—	
	Propagation delay time (L → H)	t_{pLH}	$V_{CC} = 5\text{V}$ $I_F = 15\text{mA}$ $R_L = 280\Omega$ $T_a = 25^\circ\text{C}$	TLP1004A(F)	—	3	—	μs
				TLP1005A(F)	—	6	—	
	Propagation delay time (H → L)	t_{pHL}		TLP1004A(F)	—	6	—	
				TLP1005A(F)	—	3	—	
Rise time	t_r	(Note)		—	0.1	—		
Fall time	t_f			—	0.05	—		

*1. 0mA for TLP1004A(F). 15mA for TLP1005A(F)

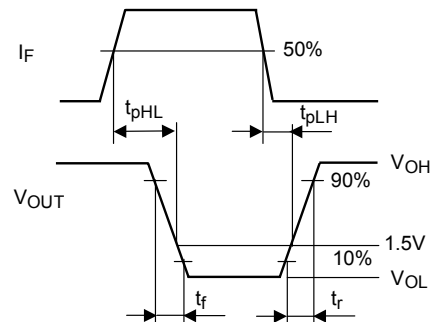
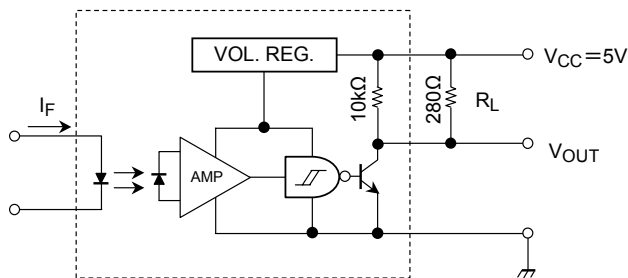
*2. 15mA for TLP1004A(F). 0mA for TLP1005A(F).

Note: Switching time test circuit

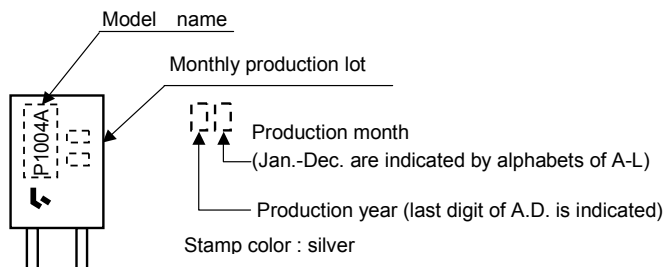
TLP1004A(F)



TLP1005A(F)



Product Indication



Abbreviation	Type
P1004A	TLP1004A(F)
P1005A	TLP1005A(F)

Precaution

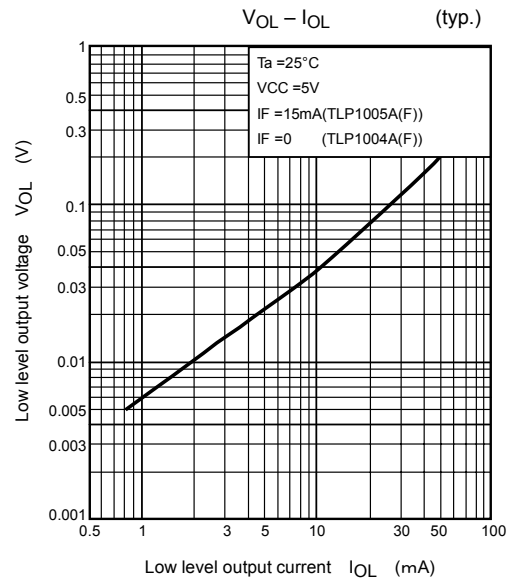
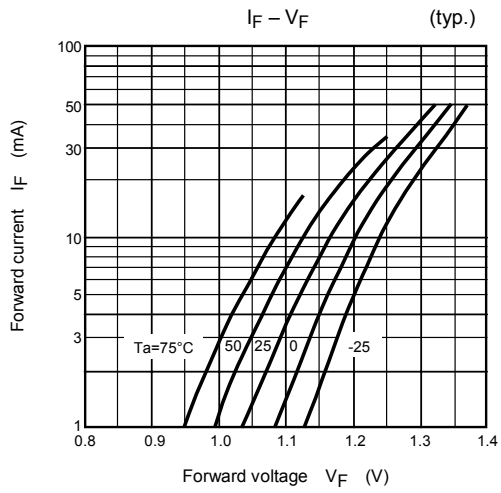
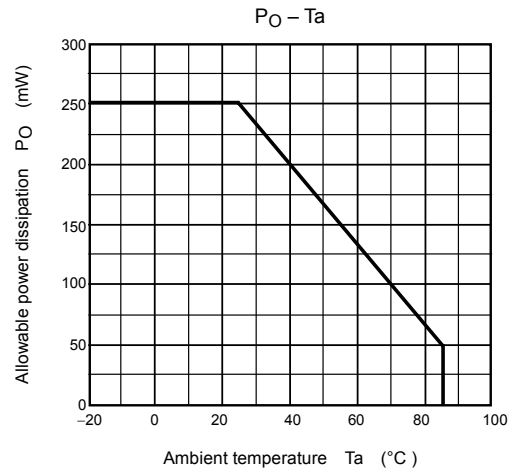
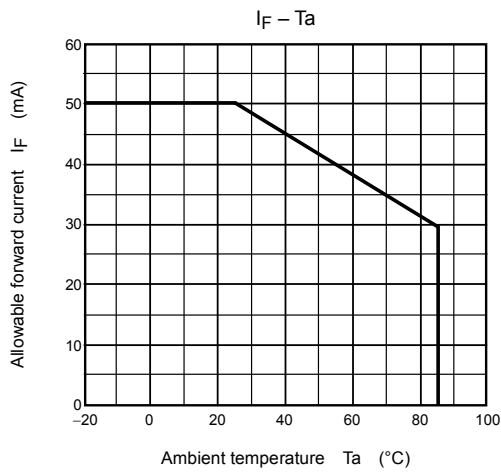
Please be careful of the followings.

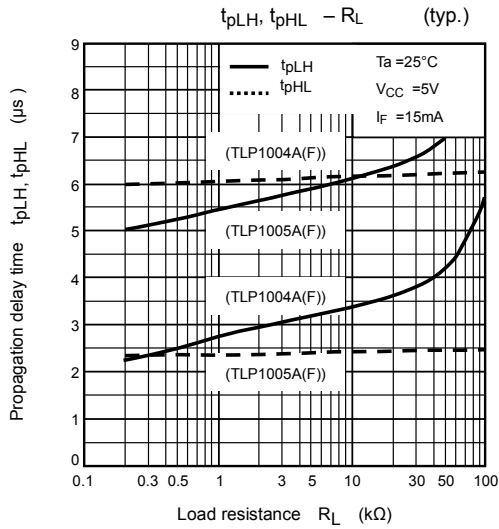
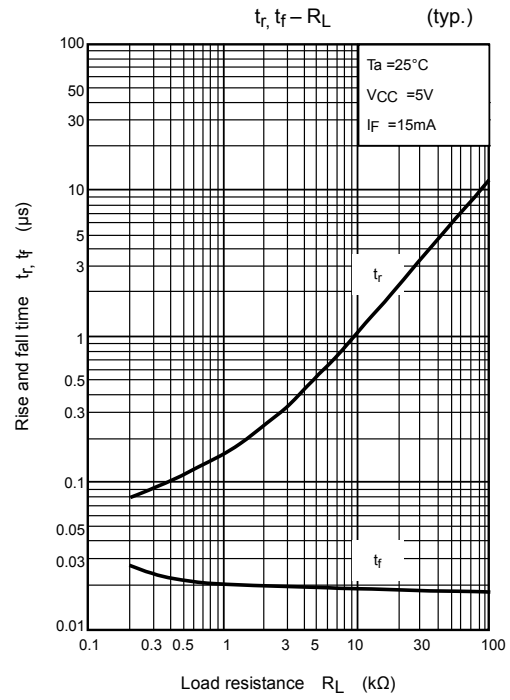
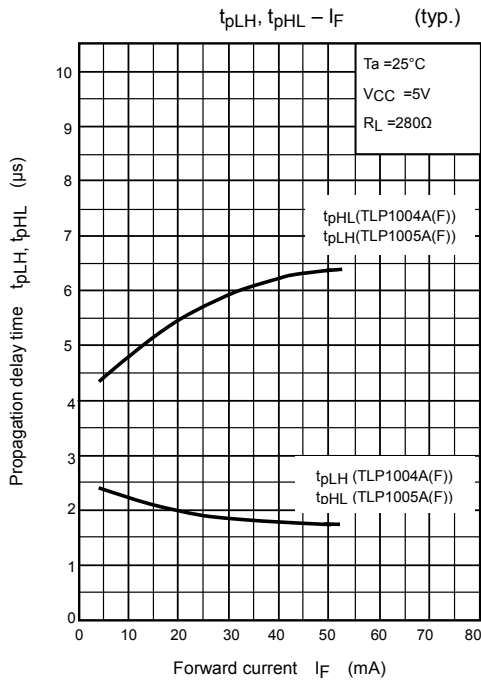
1. Soldering should be performed after lead forming.
2. If chemicals are used for cleaning, the soldered surface only shall be cleaned with chemicals avoiding the whole cleaning of the package.
3. The container is made of polycarbonate. polycarbonate is usually stable with acid, alcohol, and aliphatic hydrocarbons however, with petrochemicals (such as benzene, toluene, and acetone), alkali, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate becomes cracked, swollen, or melted. Please take care when choosing a packaging material by referencing the table below.

<Chemicals To Avoid With Polycarbonate>

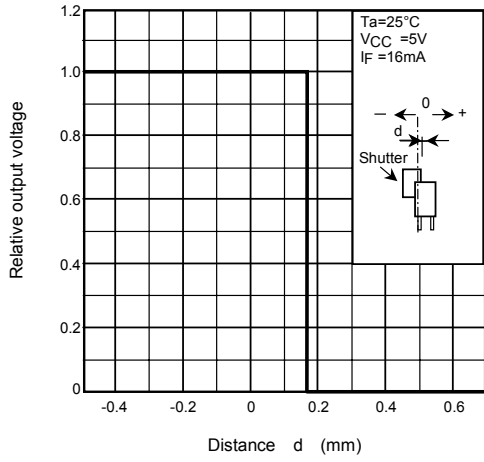
	Phenomenon	Chemicals
A	Little deterioration but staining	<ul style="list-style-type: none"> • Nitric acid (low concentration), hydrogen peroxide, chlorine
B	Cracked, crazed, or swollen	<ul style="list-style-type: none"> • Acetic acid (70% or more) • Gasoline • Methyl ethyl ketone, ethyl acetate, butyl acetate • Ethyl methacrylate, ethyl ether, MEK • Acetone, m-amino alcohol, carbon tetrachloride • Carbon disulfide, trichloroethylene, cresol • Thinners, oil of turpentine • Triethanolamine, TCP, TBP
C	Melted (): Used as solvent.	<ul style="list-style-type: none"> • Concentrated sulfuric acid • Benzene • Styrene, acrylonitrile, vinyl acetate • Ethylenediamine, diethylenediamine • (Chloroform, methyl chloride, tetrachloromethane, dioxane, 1, 2-dichloroethane)
D	Decomposed	<ul style="list-style-type: none"> • Ammonia water • Other alkali

4. During 100 μ s after turning on VCC, output voltage changes for stabilizing the inner circuit.
5. Supply the by-pass condenser up to 0.01 μ F between VCC and GND near device to stabilize the power supply line.

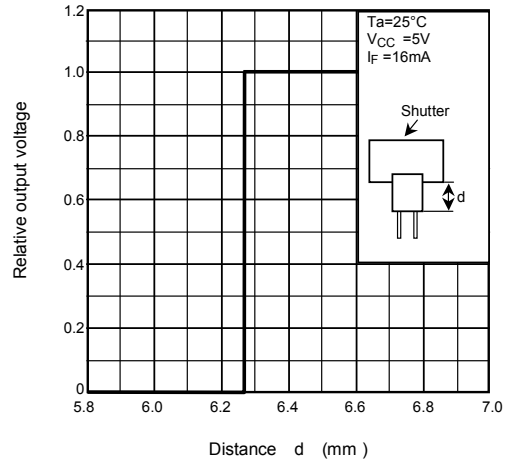




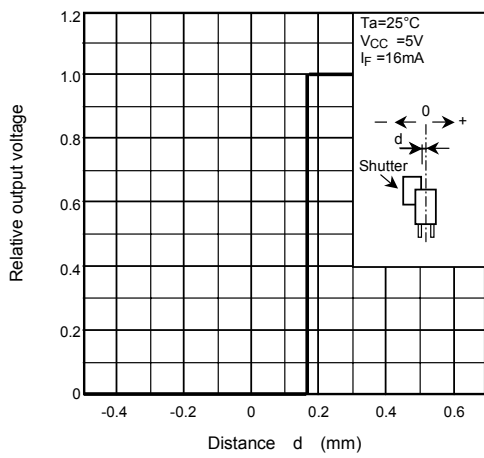
TLP1004A(F) Detecting Position Characteristics (1) (typ.)



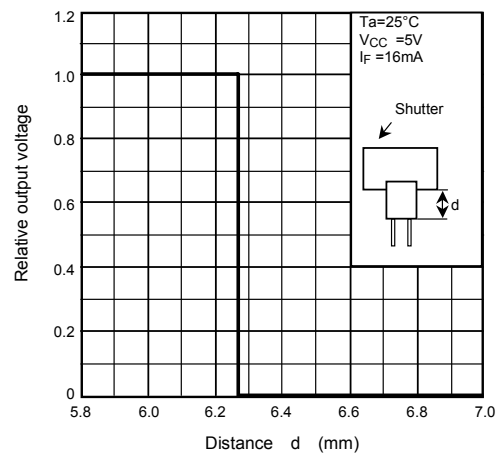
TLP1004A(F) Detecting Position Characteristics (2) (typ.)



TLP1005A(F) Detecting Position Characteristics (1) (typ.)

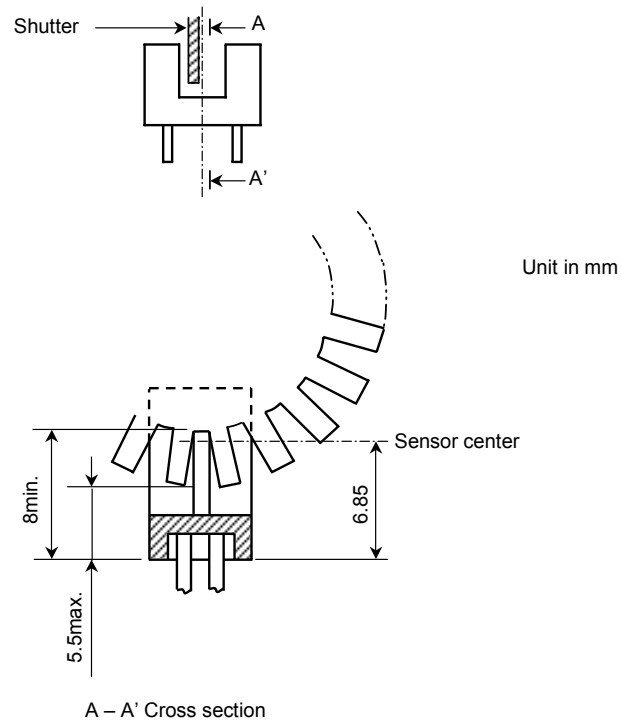


TLP1005A(F) Detecting Position Characteristics (2) (typ.)



Positioning Of Shutter And Device

To operate correctly, make sure that the shutter and the device are positioned as shown in the figure below.
The slit pitch of the shutter must be set wider than the slit width of the device.
Determine the width taking the switching time into consideration.



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